

1. General description

Silicon Carbide Schottky diode in a TO247-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability ($T_{j(max)} = 175\text{ °C}$)

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

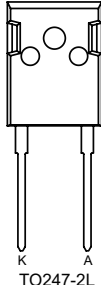

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
V _{RRM}	repetitive peak reverse voltage			1200			V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 143 °C; Fig. 1 ; Fig. 2 ; Fig. 3		10			A
T _j	junction temperature			-55 to 175			°C
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; Fig. 5		-	1.42	1.60	V
		I _F = 10 A; T _j = 150 °C; Fig. 5		-	1.90	2.30	V
		I _F = 10 A; T _j = 175 °C; Fig. 5		-	2.00	2.50	V
Dynamic characteristics							
Q _r	recovered charge	I _F = 10 A; dI _F /dt = 500 A/μs; V _R = 400 V; T _j = 25 °C; Fig. 7		-	22	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 TO247-2L	 001aaa020
2	A	anode		
mb	mb	mounting base; connected to cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WNSC2D101200W	TO247-2L	WNSC2D101200W6Q	Tube	30	TO247L-2L	10-Nov-2020

7. Marking

Table 4. Marking codes

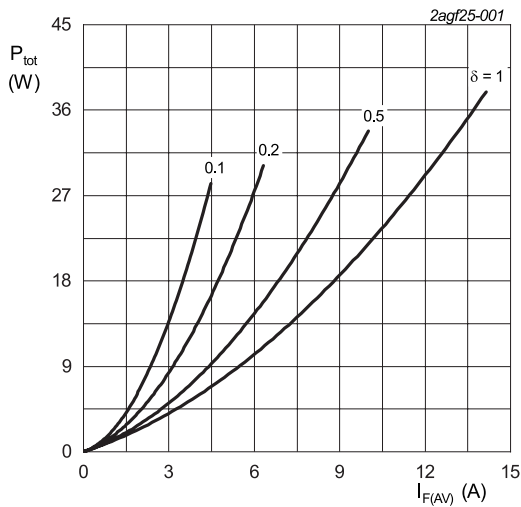
Type number	Marking codes
WNSC2D101200W	WNSC2D 101200W

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			1200	V
V_{RWM}	crest working reverse voltage			1200	V
V_R	reverse voltage	DC		1200	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; square-wave pulse; $T_{mb} \leq 143\text{ }^{\circ}\text{C}$; Fig. 1 ; Fig. 2 ; Fig. 3		10	A
I_{FRM}	repetitive peak forward current	$\delta = 0.5$; $t_p = 25\text{ }\mu\text{s}$; $T_{mb} \leq 143\text{ }^{\circ}\text{C}$; square-wave pulse		20	A
I_{FSM}	non-repetitive peak forward current	$t_p = 10\text{ ms}$; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$; sine-wave pulse		80	A
		$t_p = 10\text{ }\mu\text{s}$; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$; square-wave pulse		700	A
I^2t	I^2t for fusing	sine-wave pulse; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$; $t_p = 10\text{ ms}$		32	A^2s
T_{stg}	storage temperature			-55 to 175	$^{\circ}\text{C}$
T_j	junction temperature			-55 to 175	$^{\circ}\text{C}$



$I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$
 $V_o = 0.997\text{ V}$; $R_s = 0.1192\text{ }\Omega$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

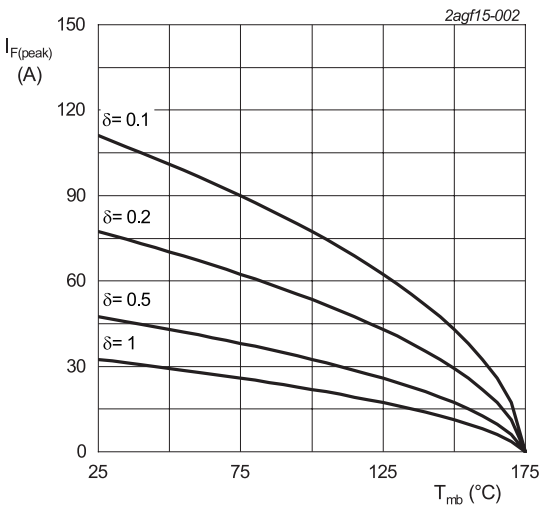


Fig. 2. Current derating as a function of mounting base temperature

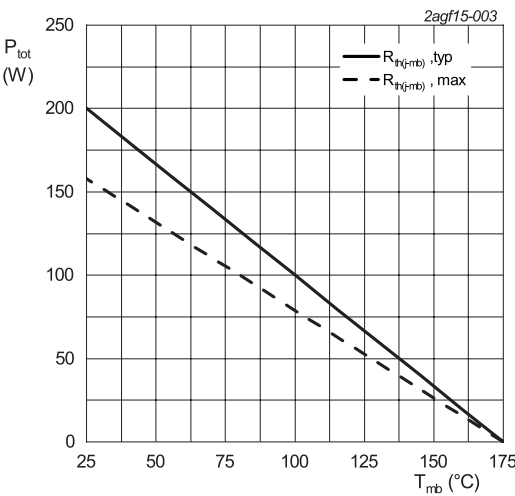


Fig. 3. Total power dissipation as a function of mounting base temperature

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 4		-	0.75	0.95	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air		-	40	-	K/W

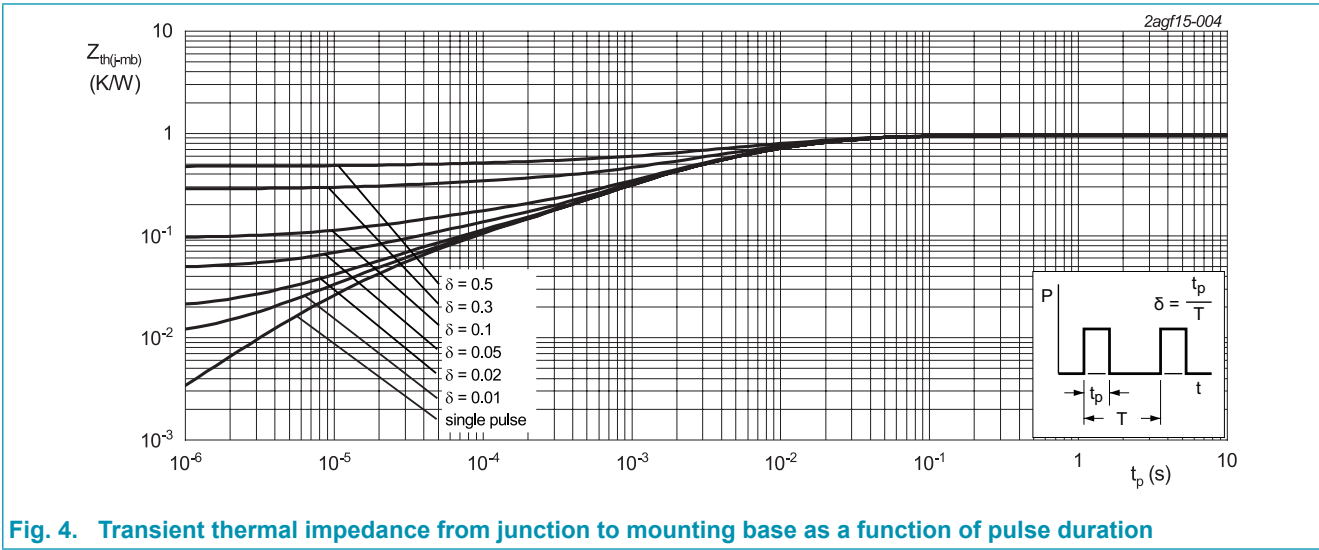
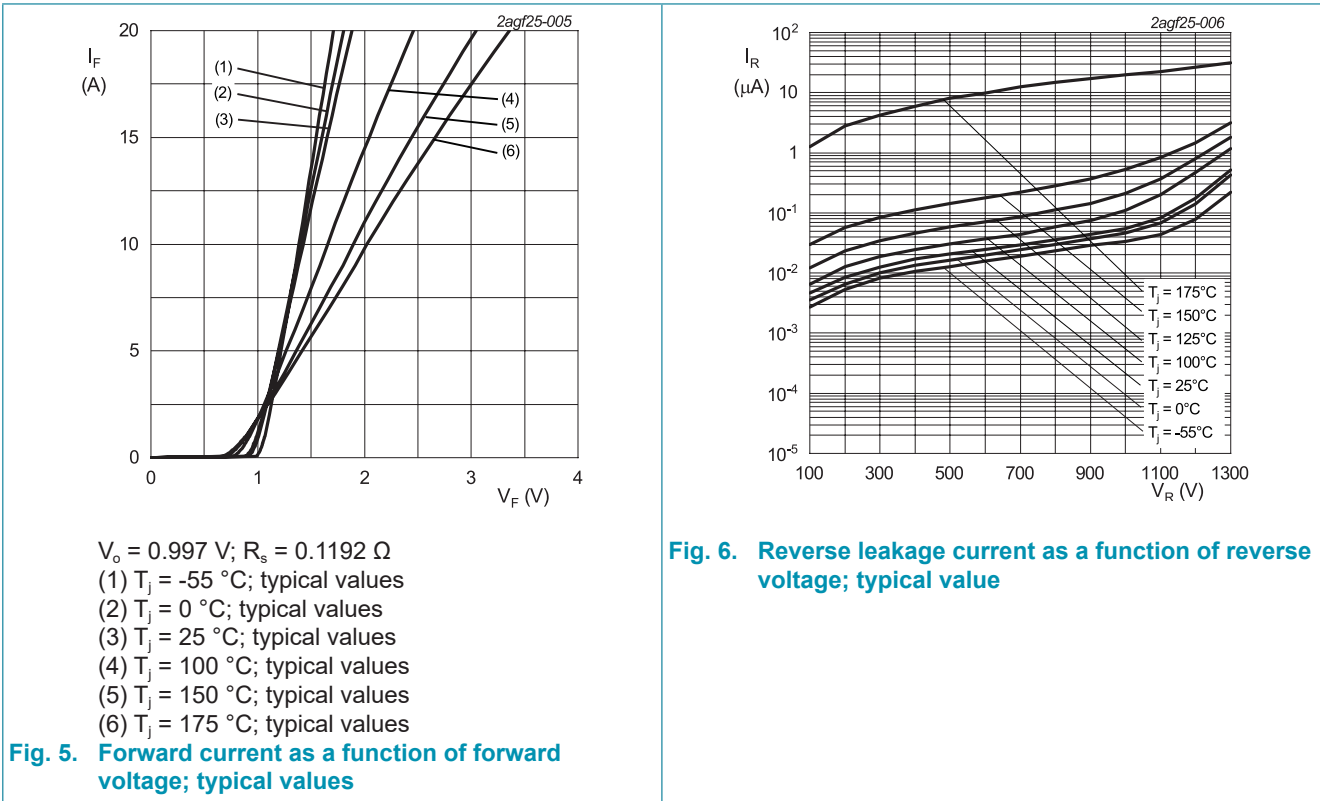


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
Static characteristics							
V _F	forward current	I _F = 10 A; T _J = 25 °C; Fig. 5		-	1.42	1.60	V
		I _F = 10 A; T _J = 150 °C; Fig. 5		-	1.90	2.30	V
		I _F = 10 A; T _J = 175 °C; Fig. 5		-	2.00	2.50	V
I _R	reverse current	V _R = 1200 V; T _J = 25 °C; Fig. 6		-	1	50	μA
		V _R = 1200 V; T _J = 175 °C; Fig. 6		-	25	500	μA
Dynamic characteristics							
Q _r	recovered charge	I _F = 10 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _J = 25 °C; Fig. 7		-	22	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _J = 25 °C		-	481	-	pF
		f = 1 MHz; V _R = 400 V; T _J = 25 °C		-	42	-	pF
		f = 1 MHz; V _R = 800 V; T _J = 25 °C		-	31	-	pF
E _{as}	non-repetitive avalanche energy	I _R = 4.2 A; L = 10 mH; T _{J(init)} = 25 °C		88	-	-	mJ



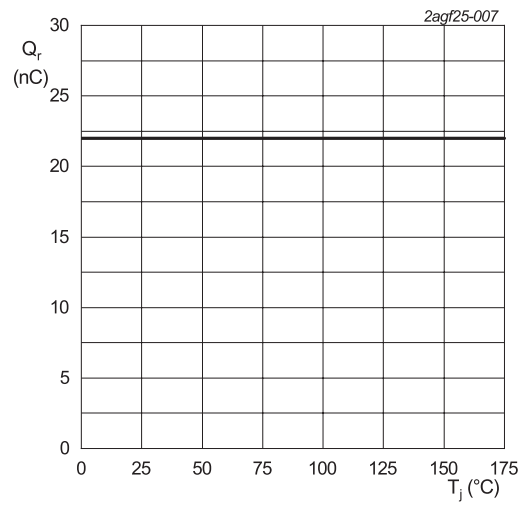


Fig. 7. Recovered charge as a function of junction temperature

11. Package outline

Plastic single-ended through-hole package; heatsink mounted;1 mounting hole;2 leads TO-247

TO247-2L

The technical drawing illustrates the package outline for the WNSC2D101200W diode. It includes three views: a top view showing the mounting hole (Ø) and lead spacing (E, E1, E2, E3); a side view showing the lead length (L, L1) and lead diameter (b, b1); and a front view showing the package height (D, D1, D2) and lead diameter (c). Dimensions are labeled with letters and numbers, and specific values are provided in the table below.

UNIT	A	A ₁	b	b ₁	c	D	D ₁ ②	D ₂	E	E ₁	E ₂	E ₃	e	L	L ₁	P ₂	p	Q	q	Ø
mm	5.20	2.10	1.40	2.20	0.70	20.60	16.20	1.20	15.75	14.22	5.20	1.80	10.90	20.72	4.75	3.60	3.70	2.60	6.18	7.30
	4.70	1.90	1.00	1.80	0.50	20.30	16.87	0.80	15.45	13.82	4.80	1.40	BSC	20.22	4.25	3.40	3.50	2.20	5.78	7.10

Note:

- Mold resin protrusion max 0.127mm.
- Metal exposed with Sn plating.

12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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